

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4510765

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	MARK C. DILLE	06/27/2017
RECEIVING PARTY DATA		
Name:	FORUM US, INC.	
Street Address:	920 MEMORIAL CITY WAY, SUITE 1000	
City:	HOUSTON	
State/Country:	TEXAS	
Postal Code:	77024	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	15140772	
CORRESPONDENCE DATA		
Fax Number:	(713)623-4846	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	713-623-4844	
Email:	sdominguez@pattersonsheridan.com,psdocketing@pattersonsheridan.com	
Correspondent Name:	PATTERSON & SHERIDAN, L.L.P.	
Address Line 1:	24 GREENWAY PLAZA, SUITE 1600	
Address Line 4:	HOUSTON, TEXAS 77046	
ATTORNEY DOCKET NUMBER:	FETI/0119US	
NAME OF SUBMITTER:	JESSIE D. HERRERA	
SIGNATURE:	/JESSIE D. HERRERA/	
DATE SIGNED:	07/19/2017	
Total Attachments: 2		
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ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Name and Address of Inventor:

1)	Mark C. DILLE 5602 Pebble Springs Drive Houston, Texas 77066
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(hereinafter referred to as Assignor), have invented a certain invention entitled:

FLUID END WITH MODULAR INTAKE MANIFOLD

for which application for Letters Patent in the United States was filed on April 28, 2016, under Serial No. 15/140,772, executed on even date herewith; and

WHEREAS, FORUM US, INC, a corporation of the State of Delaware, having a place of business at 920 Memorial City Way, Suite 1000, Houston, Texas 77024 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignor, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignor to have been received in full from said Assignee:

1. Said Assignor hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

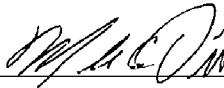
2. Said Assignor hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignor shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, conventional, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignor in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignor, their respective heirs, legal representatives and assigns.

4. Said Assignor hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignor have executed and delivered this instrument to said Assignee on the dates indicated below.

1) 06/27/2017 (DATE)



Mark C. DILLE